# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Tadao OOKAWA	10/26/2005
Mitsuru HONJO	10/27/2005
Takashi ODA	10/21/2005

#### **RECEIVING PARTY DATA**

Name:	Nitto Denko Corporation	
Street Address:	1-1-2, Shimohozumi, Ibaraki-shi,	
City:	Osaka	
State/Country:	JAPAN	
Postal Code:	567-8680	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11280624

#### **CORRESPONDENCE DATA**

Fax Number: (215)965-1210

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NAME OF SUBMITTER: Sheryl R. Neumann

Total Attachments: 2

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PATENT REEL: 016974 FRAME: 0738 CH \$40.00

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PATENT REEL: 016974 FRAME: 0739

## **ASSIGNMENT**

WHEREAS, we, <u>Tadao OOKAWA, Mitsuru HONJO and Takashi ODA</u> ,
respectively citizens of <u>Japan</u> , with respective post office addresses of
c/o NITTO DENKO CORPORATION, 1-1-2, Shimohozumi, Ibaraki-shi,
Osaka 567:8680, Japan , hereinafter generally referred to as "ASSIGNORS,"
have invented a certain new and useful
PRINTED CIRCUIT BOARD AND
MANUFACTURING METHOD THEREOF
for which we have executed a United States patent application, Application No. 11/280,624
filed November 16, 20,0and
LOCATON TO DO CONTRACTOR OF THE CONTRACTOR OF TH
ASSIGNORS authorize ASSIGNEE or ASSIGNEE's representative to insert the
Application Number and Filing date of this application if they are unknown at the time of
execution of this Assignment.
WHEREAS,NITTO DENKO CORPORATION, aJapanese
corporation having a place of business at 1-1-2, Shimohozumi, Ibaraki-shi,
Osaka 567-8680, Japan , hereinafter generally referred to as "ASSIGNEE", is
desirous of acquiring said invention and said patent application.
The second of th
NOW, THEREFORE, in consideration of the sum of One Dollar and other good and
valuable executed consideration, the full receipt and sufficiency of all of which are hereby
acknowledged and intending to be legally bound hereby, we, the undersigned ASSIGNORS,
hereby agree to sell, assign, transfer and convey and by these presents do sell, assign
transfer
and convey unto the above-named ASSIGNEE, the whole and entire right, title and interest
in and to said invention as described in the above patent application, for the
territory of the United States and its possessions and territories and all foreign
countries;
in and to said invention as described and as a latter of the LCC of the
in and to said invention as described and any and all related United States and
foreign patents applications disclosing said invention, including provisionals, non-
provisionals, divisions and continuations thereof, along with all rights of priority
created by patent application under treaty relating thereto; and

PATENT REEL: 016974 FRAME: 0740 in and to all United States and foreign patents which may be granted on any and all of said patent applications, including extensions, reissues and reexamination certificates thereof;

said invention, application(s) and patent(s) to be held and enjoyed by the above named ASSIGNEE, for ASSIGNEE's own use and benefit, and for ASSIGNEE's legal representatives

and assigns to the full end of the term or terms for which said patent(s) may be granted, as fully and entirely as the same would have been held by the undersigned ASSIGNORS had this assignment and sale not been made; and for the aforesaid consideration ASSIGNORS hereby covenant, agree and undertake to execute, whenever requested by the above named ASSIGNEE, all patent applications, assignments, lawful oaths and any other papers which ASSIGNEE may deem necessary or desirable for securing to ASSIGNEE or for maintaining for ASSIGNEE all the patent(s) hereby assigned or agreed to be assigned; all without further compensation to the undersigned ASSIGNORS.

October 26, 2005	TadaO OOKAWA	(Seal)
(Date)	Tadao OOKAWA	(Deal)
October 27, 2005	Mitsuru HONJO	(Seal)
(Date)	Mitsuru HONJO	(DCai)
October 31 , 2005	Takashr Oda	(Seal)
(Date)	Takashi ODA	

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**RECORDED: 01/05/2006**